

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: KIM, Sangyum; CHOI, Chang Hee; JO, Cha Jae; KIM, Jeong Ik; WOO, Kyung Nyung; KI, Joon Seo; MOON, Hong Gi

SERIAL NO.: 10/720,579 ART UNIT: 1753

FILED: November 24, 2003 EXAMINER: Wong, E.

TITLE: METHOD FOR MANUFACTURING VERY LOW ROUGHNESS  
ELECTRODEPOSITED COPPER FOIL AND ELECTRODEPOSITED COPPER  
FOIL MANUFACTURED THEREBY

AMENDMENT "A"

Director of the U.S. Patent  
and Trademark Office  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action of August 21, 2007, having a response with a one-month Extension of Time due by December 21, 2007, please enter the amendments provided herein and consider the following remarks.

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CERTIFICATE OF MAILING UNDER 37 CFR 1.8(a)

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

Sir:

I hereby certify that the attached correspondence comprising:

AMENDMENT "A"

is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to:

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P. O. Box 1450  
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or by electronic filing on December 10, 2007.

Respectfully submitted,

<u>December 10, 2007</u>	/Andrew W. Chu/
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